勝 特 力材料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw

Thick Film Chip Resistors

100

# **Thick Film Chip Resistors** 01005, 0201, 0402, 0603, 0805, 1206, 1210, 1812, 2010, 2512

Type: ERJ XG, 1G, 2G, 3G, 6G, 8G, 14, 12, 12Z, 1T 100Y.COM.TW



WWW.100Y.CO

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#### Features

- Small size and lightweight
- High reliability
- Metal glaze thick film resistive element and three layers of electrodes
- Compatible with placement machines Taping packaging available
- Suitable for both reflow and flow soldering
- EC 60115-8, JIS C 5201-8, EIAJ RC-2134B **Reference Standards**

### Explanation of Part Numbers

● ERJXGN, 1GE, 2GE, 3GE, 6GE, 8GE, 14, 12, 12Z, 1T Series, ±5 % type

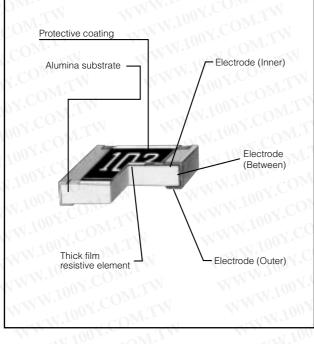
E	2 R	3 J	4 3	5 6 G E	7 <b>Y</b>	8 	9	10 0	11 12 <b>2 V</b>	
Product Code	Size, Power	er Bating	IDM-	Marking	Resista	nce Tolerance	1.1	1	Packaging Methods	V COMP.
Thick Film	Type : inches		Code	Marking	Code	Tolerance	T.D	Code	Packaging	Туре
Chip Resistors	XGN: 01005	-	Y	Value Marking on black side	J	±5 % Jumper	M.	Y	Proposed Corrier Taping	ERJXGN
	2GE : 0402 3GE : 0603	0.1 W 0.1 W	*Nil	No marking		W.100Y.COM	С	Pressed Carrier Taping 2 mm pitch, 15000 pcs.	ERJ1GE	
	6GE : 0805	0.125 W					x	Punched Carrier Taping 2 mm pitch, 10000 pcs.	ERJ2GE	
	8GE : 1206 14 : 1210 12 : 1812	0.25 W 0.5 W 0.75 W	the th Decin	nird one denotes numb mal Point is expressed			v	Rupphod Carrier Taping	ERJ3GE ERJ6GE ERJ8GE	
	12Z : 2010 1T : 2512	0.75 W 1 W		per is expressed by R(	JU.	WWW.100	<del>, 1.0</del> 		Embossed CarrierTaping	ERJ14

\* When omitted, the rest of the P/N factors shall be moved up respectively. WWW.100X.COM (Only XGN, 1GN, 2GE type)

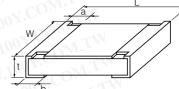
ERJ1T

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### Construction



### Dimensions in mm (not to scale)



Туре	1.1	Mass (Weight)				
(inches)		W	а	b	t	(g/1000 pcs.)
ERJXG (01005)	0.40 <sup>±0.02</sup>	0.20 <sup>±0.02</sup>	0.10 <sup>±0.03</sup>	0.10 <sup>±0.03</sup>	0.13 <sup>±0.02</sup>	0.04
ERJ1G (0201)	0.60 <sup>±0.03</sup>	$0.30^{\pm 0.03}$	0.10 <sup>±0.05</sup>	0.15 <sup>±0.05</sup>	0.23 <sup>±0.03</sup>	0.15
ERJ2G (0402)	1.00 <sup>±0.05</sup>	0.50 <sup>±0.05</sup>	0.20 <sup>±0.10</sup>	0.25 <sup>±0.05</sup>	$0.35^{\pm 0.05}$	0.8
ERJ3G (0603)	1.60 <sup>±0.15</sup>	0.80 <sup>+0.15</sup> <sub>-0.05</sub>	0.30 <sup>±0.20</sup>	0.30 <sup>±0.15</sup>	0.45 <sup>±0.10</sup>	2
ERJ6G (0805)	2.00 <sup>±0.20</sup>	1.25 <sup>±0.10</sup>	0.40 <sup>±0.20</sup>	0.40 <sup>±0.20</sup>	0.60 <sup>±0.10</sup>	4
ERJ8G (1206)	3.20 <sup>+0.05</sup> <sub>-0.20</sub>	$1.60^{+0.05}_{-0.15}$	0.50 <sup>±0.20</sup>	0.50 <sup>±0.20</sup>	0.60 <sup>±0.10</sup>	10
ERJ14 (1210)	3.20 <sup>±0.20</sup>	2.50 <sup>±0.20</sup>	0.50 <sup>±0.20</sup>	0.50 <sup>±0.20</sup>	0.60 <sup>±0.10</sup>	16
ERJ12 (1812)	4.50 <sup>±0.20</sup>	3.20 <sup>±0.20</sup>	0.50 <sup>±0.20</sup>	0.50 <sup>±0.20</sup>	0.60 <sup>±0.10</sup>	27
ERJ12Z (2010)	5.00 <sup>±0.20</sup>	2.50 <sup>±0.20</sup>	0.60 <sup>±0.20</sup>	0.60 <sup>±0.20</sup>	0.60 <sup>±0.10</sup>	27
ERJ1T (2512)	6.40 <sup>±0.20</sup>	3.20 <sup>±0.20</sup>	0.65 <sup>±0.20</sup>	0.60 <sup>±0.20</sup>	0.60 <sup>±0.10</sup>	45
OWIN		N.	NN.10		0 <sub>W.r</sub>	
OM.T				00 <sup>1.C</sup>	COM.	

#### Ratings -For Registor

l Ratings For Resisto	pr>						
Type (inches)	Power Rating at 70 °C (W)	Limiting Element Voltage (Maximum RCWV) <sup>(1)</sup> (V)	Maximum Overload Voltage <sup>(2)</sup> (V)	Resistance Tolerance (%)	Resistance Range (Ω)	T.C.R. [×10 <sup>-6</sup> /°C (ppm/°C)]	Category Temperature Range (Operating Temperature Range (°C)
ERJXG (01005)	0.031	15	30	±5	4.7 to 1 M (E24)	<10 $\Omega$ : -100 to +600 10 $\Omega$ to 100 $\Omega$ : ±300 100 $\Omega$ < : ±200	
ERJ1G (0201)	0.05	25	50	±5	1 to 10 M (E24)	WWW.	-55 to +125
ERJ2G (0402)	0.1	50	100	±5	1 to 10 M (E24)	<10 Ω: –100 to +600	-55 to +155
ERJ3G (0603)	0.1	75	150	±5	1 to 10 M (E24)	WW	-55 to +155
ERJ6G (0805)	0.125	150	200	±5	1 to 10 M (E24)	WW N	-55 to +155
ERJ8G (1206)	0.25	200	400	±5	1 to 10 M (E24)	10 Ω to 1 MΩ: ±200	-55 to +155
ERJ14 (1210)	0.5	200	400	±5	1 to 10 M (E24)	V W	-55 to +155
ERJ12 (1812)	0.75	200	500	±5	1 to 10 M (E24)	WT	-55 to +155
ERJ12Z (2010)	0.75	200	500	±5	1 to 10 M (E24)	1 MΩ<: -400 to +150	-55 to +155
ERJ1T (2512)	1	200	500	±5	1 to 1 M (E24)		-55 to +155

(1) Rated Continuous Working Voltage (RCWV) shall be determined from RCWV=VPower Rating × Resistance Values, or Limiting Element Voltage (max. RCWV) listed above, whichever less.

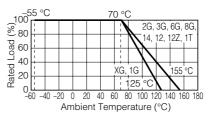
(2) Overload (Short-time Overload) Test Voltage (SOTV) shall be determined from SOTV=2.5×Power Rating or max. Overload Voltage listed above whichever less.

#### <For Jumper>

a or bampors		
Type (inches)	Rated Current (A)	Maximum Overload Current (A)
ERJXG (01005) ERJ1G (0201)	0.5	WW.109 COM.I
ERJ2G (0402)		
ERJ3G (0603)	I	Z S
ERJ6G (0805)		.10°
ERJ8G (1206)		
ERJ14 (1210)	2	4
ERJ12 (1812)	2	4
ERJ12Z (2010)		
ERJ1T (2512)		

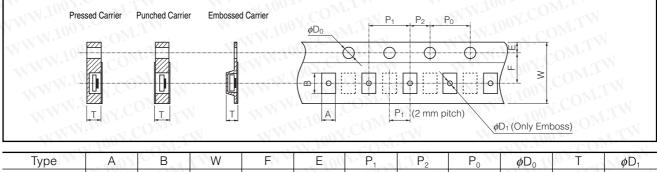
### Power Derating Curve

For resistors operated in ambient temperatures above 70 °C, power rating shall be derated in accordance with the figure below.



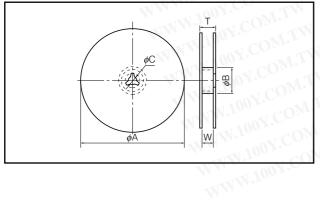
Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use. Should a safety concern arise regarding this product, please be sure to contact us immediately.

Panasonic Packaging Methods (T	onic <sup>胜件</sup> 胜件		料 886-3-5753170 (海) 86-21-34970699 彩圳) 86-755-8329878 ww. 100y. com. tw	Thick Film Chip Resistors
Standard Quantity	aping)	T.T.W	WWW.100X.	OM.TW
Туре	Kind of Ta	oing	Pitch (P1)	Quantity
ERJXG	Pressed Carrier Taping		WW 1001	20000 pcs./reel
ERJ1G			2 mm	15000 pcs./reel
ERJ2G	WWW.100 COM. TW		WWW.L	10000 pcs./reel
ERJ3G	Punched Carrier Taping		WW.Io	COM.
ERJ6G	Punched Camer	Taping	W WILL	OY.CONLTW
ERJ8G			N WWW	
ERJ14	WWW.I	V.COM.	4 mm	5000 pcs./reel
ERJ12	Embassed Carrie	r Taning	WW	
ERJ12Z	Embossed Carrie	aping	IN N.	
ERJ1T			WW WT	4000 pcs./reel



туре	$\neg$	D	vv			1	2	0	$\varphi D_0$		$\varphi D_1$
ERJXG	$0.24^{\pm 0.03}$	$0.45^{\pm 0.03}$	W	W	NN.	N.COr	WT.	1	NN	$0.31^{\pm 0.05}$	17-1
ERJ1G	$0.38^{\pm 0.05}$	$0.68^{\pm 0.05}$			WW.IU	2.00 <sup>±0.10</sup>	M.		WWW.	$0.42^{\pm 0.05}$	002
ERJ2G	0.67 <sup>±0.05</sup>	1.17 <sup>±0.05</sup>		N N	IN I	001.	M.T.Y			$0.52^{\pm 0.05}$	$0^{\underline{M}.\underline{r}}$
ERJ3G <	1.10 <sup>±0.10</sup>	1.90 <sup>±0.10</sup>	8.00 <sup>±0.20</sup>	3.50 <sup>±0.05</sup>	N.W. I.	1001.0	TIM		MM.	$0.70^{\pm 0.05}$	I.I.
ERJ6G	1.65 <sup>±0.15</sup>	$2.50^{\pm 0.20}$	DNI-		<b></b> +0.10	.YooX.	0.00+0.05	4 00+0.10	1 50+0.10	0.84 <sup>±0.05</sup>	.00
ERJ8G	2.00 <sup>±0.15</sup>	$3.60^{\pm 0.20}$	OW.L.	-1	1.75 <sup>±0.10</sup>	1.100	2.00 <sup>±0.05</sup>	4.00 <sup>±0.10</sup>	1.50 <sup>+0.10</sup>	0.84	a COMP
ERJ14					N.	4.00 <sup>±0.10</sup>	MON	L.		N.100	1.0+0.10
ERJ12	$3.50^{\pm 0.20}$	4.80 <sup>±0.20</sup>	COL	W	WW	001	1.00	WT	N.	1.00 <sup>±0.10</sup>	01.0
ERJ12Z				5.50 <sup>±0.20</sup>	NV.	11.10	V.CON	Wn	1	1.00-000	1.5 min.
ERJ1T	3.60 <sup>±0.20</sup>	$6.90^{\pm 0.20}$	Mos			N.10	CO	1.1		-WW.	

### • Taping Reel



W.100		1.1	ſ		(Unit : mm)	
Туре	φA	φB	φC	W	A TOUL	
ERJXG	N.C.	17	N	WW	V.CO.	
ERJ1G					NW.100	
ERJ2G	1001.0		N.	N	1.4	
ERJ3G			III	9.0 <sup>±1.0</sup>	11.4 <sup>±1.0</sup>	
ERJ6G	190.0+0	60 min	13.0 <sup>±1.0</sup>			
ERJ8G	180.0 <sup>+0</sup> -3.0	60 min.	13.0			
ERJ14	N.100					
ERJ12						
ERJ12Z				13.0 <sup>±1.0</sup>	15.4 <sup>±2.0</sup>	
ERJ1T						

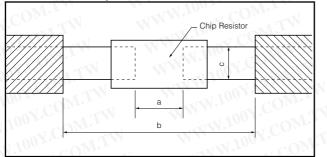
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# Thick Film Chip Resistors

### Recommended Land Pattern

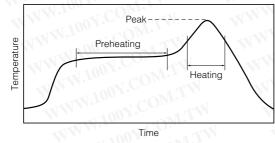
In case of flow soldering, the land width must be smaller than the Chip Resistor width to control the solder amount properly. Generally, the land width should be 0.7 to 0.8 times (W) of the width of chip resistor. In case of reflow soldering, solder amount can be adjusted, therefore the land width should be set to 1.0 to 1.3 times chip resistor width (W).



set to 1.0 to 1.3	times crip res	SISTON MIDTIN (M	).
Туре	D	imensions (mr	n)
(inches)	а	b	С
ERJXG(01005)	0.15 to 0.20	0.5 to 0.7	0.20 to 0.25
ERJ1G(0201)	0.3 to 0.4	0.8 to 0.9	0.25 to 0.35
ERJ2G(0402)	0.5 to 0.6	1.4 to 1.6	0.4 to 0.6
ERJ3G(0603)	0.7 to 0.9	2 to 2.2	0.8 to 1
ERJ6G(0805)	1 to 1.4	3.2 to 3.8	0.9 to 1.4
ERJ8G(1206)	2 to 2.4	4.4 to 5	1.2 to 1.8
ERJ14(1210)	2 to 2.4	4.4 to 5	1.8 to 2.8
ERJ12(1812)	3.3 to 3.7	5.7 to 6.5	2.3 to 3.5
ERJ12Z(2010)	3.6 to 4	6.2 to 7	1.8 to 2.8
ERJ1T(2512)	5 to 5.4	7.6 to 8.6	2.3 to 3.5

### Recommended Soldering Conditions Recommendations and precautions are described below.

- Recommended soldering conditions for reflow
  Reflow soldering shall be performed a maximum of two times.
- Please contact us for additional information when used in conditions other than those specified.
- Please measure the temperature of the terminals and study every kind of solder and printed circuit board for solderability before actual use.



• Recommended soldering conditions for flow

Wn	Temperature	Time
Preheating	140 °C to 160 °C	60 s to 120 s
Main heating	Above 200 °C	30 s to 40 s
Peak	235 ± 5 °C	max. 10 s

For lead-free soldering (Example : Sn/Ag/Cu)

For soldering (Example : Sn/Pb)

	<b>—</b>	- Hill
· · · · · · · · · · · · · · · · · · ·	Temperature	Time
Preheating	150 °C to 180 °C	60 s to 120 s
Main heating	Above 230 °C	30 s to 40 s
Peak	max. 260 °C	max. 10 s

	For solo	dering	For lead-free soldering		
	Temperature	Time	Temperature	Time	
Preheating	140 °C to 180 °C	60 s to 120 s	150 °C to 180 °C	60 s to 120 s	
Soldering	245 ± 5 °C	20 s to 30 s	max. 260 °C	max. 10 s	

## ▲ Safety Precautions

The following are precautions for individual products. Please also refer to the precautions common to Fixed Resistors shown on page ER2 of this catalog.

- 1. Take measures against mechanical stress during and after mounting of Thick Film Chip Resistors (hereafter called the resistors) so as not to damage their electrodes and protective coatings.
- 2. If a transient load (heavy load in a short time) like a pulse is expected to be applied, check and evaluate the operations of the resistors when installed in your products before use.

Never exceed the rated power. Otherwise, the performance and/or reliability of the resistors may be impaired.

- 3. Do not use halogen-based or other high-activity flux. Otherwise, the residue may impair the resistors' performance and/or reliability.
- 4. When soldering with a soldering iron, never touch the resistors' bodies with the tip of the soldering iron. When using a soldering iron with a high temperature tip, finish soldering as quickly as possible (within three seconds at 350 °C max.).
- 5. As the amount of applied solder becomes larger, the mechanical stress applied to the resistors increases, causing problems such as cracks and faulty characteristics. Avoid applying an excessive amount of solder.
- 6. Do not apply shock to the resistors or pinch them with a hard tool (e.g. pliers and tweezers). Otherwise, the resistors' protective coatings and bodies may be chipped, affecting their performance.
- 7. Avoid excessive bending of printed circuit boards in order to protect the resistors from abnormal stress.

## ▲ Safety Precautions

(Common precautions for Fixed Resistors)

- When using our products, no matter what sort of equipment they might be used for, be sure to make a written agreement on the specifications with us in advance. The design and specifications in this catalog are subject to change without prior notice.
- Do not use the products beyond the specifications described in this catalog.
- This catalog explains the quality and performance of the products as individual components. Before use, check and evaluate their operations when installed in your products.
- Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other significant damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/gas equipment, rotating equipment, and disaster/crime prevention equipment.
- \* Systems equipped with a protection circuit and a protection device
- \* Systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault

### (1) Precautions for use

- These products are designed and manufactured for general and standard use in general electronic equipment (e.g. AV equipment, home electric appliances, office equipment, information and communication equipment)
- These products are not intended for use in the following special conditions. Before using the products, carefully check the effects on their quality and performance, and determine whether or not they can be used.
  - 1. In liquid, such as water, oil, chemicals, or organic solvent
  - 2. In direct sunlight, outdoors, or in dust
  - 3. In salty air or air with a high concentration of corrosive gas, such as Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, or NO<sub>2</sub>
  - 4. Electric Static Discharge (ESD) Environment
    - These components are sensitive to static electricity and can be damaged under static shock (ESD). Please take measures to avoid any of these environments.
    - Smaller components are more sensitive to ESD environment.
  - 5. Electromagnetic Environment
    - Avoid any environment where strong electromagnetic waves exist.
  - 6. In an environment where these products cause dew condensation
  - 7. Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin or other materials
- These products generate Joule heat when energized. Carefully position these products so that their heat will not affect the other components.
- Carefully position these products so that their temperatures will not exceed the category temperature range due to the effects of neighboring heat-generating components. Do not mount or place heat-generating components or inflammables, such as vinyl-coated wires, near these products.
- Note that non-cleaning solder, halogen-based highly active flux, or water-soluble flux may deteriorate the performance or reliability of the products.
- Carefully select a flux cleaning agent for use after soldering. An unsuitable agent may deteriorate the performance or reliability. In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues. Otherwise, the insulation performance may be deteriorated.

### (2) Precautions for storage

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of 5 °C to 35 ° C and a relative humidity of 45 % to 85 %.

Even within the above guarantee periods, do not store these products in the following conditions. Otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

1. In salty air or in air with a high concentration of corrosive gas, such as Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, or NO<sub>2</sub>

2. In direct sunlight

#### <Package markings>

Package markings include the product number, quantity, and country of origin. In principle, the country of origin should be indicated in English.